

MT29F16G08ABECBM72A3WC1 TR Information


For Reference Only

Part Number [MT29F16G08ABECBM72A3WC1 TR](#)
Manufacturer Micron Technology Inc.
Category Integrated Circuits (ICs)
Memory
Description IC FLASH 16GBIT WAFER
Package Die
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com



[Request a Quote](#)

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


MT29F16G08ABECBM72A3WC1 TR Specifications

Manufacturer Part Number	MT29F16G08ABECBM72A3WC1 TR
Manufacturer	Micron Technology Inc.
Category	Integrated Circuits (ICs) Memory
Package	Die
Series	-
Memory Type	Non-Volatile
Memory Format	FLASH
Technology	FLASH - NAND
Memory Size	16Gb (2G x 8)
Memory Interface	Parallel
Clock Frequency	-
Write Cycle Time - Word, Page	-
Access Time	-
Voltage - Supply	2.7 V ~ 3.6 V
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	Die
Supplier Device Package	Die

[Report errors?](#)

MT29F16G08ABECBM72A3WC1 TR Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MT29F16G08ABECBM72A3WC1 TR Payment Methods



MT29F16G08ABECBM72A3WC1 TR Shipping Methods



If you have any question about MT29F16G08ABECBM72A3WC1 TR, please do not hesitate to contact us!

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